

SSC8L312PN6

N-Channel Enhanced MOSFET

> Features

VDS	VGS	RDSON Typ.	ID	
201/	1201/	0.95mΩ@10V	2004	
30V	±20V	1.55mΩ@4V5	200A	

> Description

This device is N-Channel enhancement MOSFET. Uses SGT technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. 100% UIS Tested.

Applications

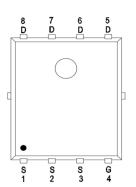
- Load Switch
- Portable Devices
- DCDC conversion
- Power supplies
- Synchronous rectification

Ordering Information

Device	Package	Shipping	
SSC8L312PN6	PDFN5X6	5000/Reel	

Pin configuration

Top view





PDFN5X6



(XX: product year / YY: product week)



➤ Absolute Maximum Ratings(T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit		
V _{DSS}	Drain-to-Source Voltage		30	V	
V _{GSS}	Gate-to-Source Volt	tage	±20	V	
	Continuous Drain Current d	T _C =25°C	200		
l _D		Tc=100°C	99	Α	
	Continuous Drain Current ^a	T _A =25°C	60		
IDSM		T _A =70°C	41	Α	
I _{DM}	Pulsed Drain Current ^b		400	Α	
	Power Dissipation c	Tc=25°C	84	W	
P _D		Tc=100°C	33		
_	Power Dissipation ^a	T _A =25°C	7.5	W	
P _{DSM}		T _A =70°C	4.8		
I _{AS}	Avalanche Current b L=0.1mH Single Pulse		54	Α	
Eas	Avalanche Energy b L=0.1mH Single Pulse		146	mJ	
TJ	Operation junction temperature		-55~150	96	
T _{STG}	Storage temperature range		-55~150	°C	

➤ Thermal Resistance Ratings(T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
R _{0JA}	Junction-to-Ambient Thermal Resistance ^a	15	°C/W
R ₀ JC	R _{0JC} Junction-to-Case Thermal Resistance		C/VV

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25°C.The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on $T_{J(MAX)}$ =150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

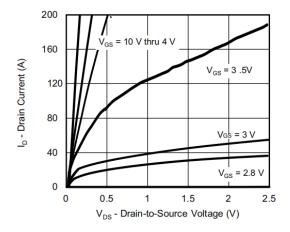


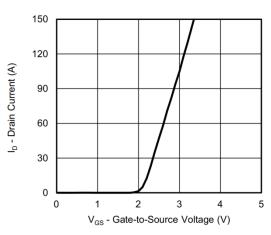
➤ Electronics Characteristics(T_A=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
V _{(BR)DSS}	Drain-Source Breakdown Voltage	VGS=0V, ID=250uA	30			V
V _{GS (th)}	Gate Threshold Voltage	VDS=VGS, ID=250uA	1.3	1.8	2.3	V
Б	Drain-Source On-	VGS=10V , ID=30A		0.95	1.15	m C
R _{DS(on)}	Resistance	VGS=4.5V , ID=20A		1.55	1.9	mΩ
I _{DSS}	Zero Gate Voltage Drain Current	VDS=30V, VGS=0V			1	uA
I _{GSS}	Gate-Source leak current	VGS=±20V, VDS=0V			±100	nA
G _{FS}	Transconductance	VDS=5V, ID=20A		100		S
V _{SD}	Forward Voltage	VGS=0V, IS=20A		0.8	1.3	V
Rg	Gate Resistance	VDS=0V, f=1MHz		1.3		Ω
Ciss	Input Capacitance			5850		
Coss	Output Capacitance	VDS=15V, VGS=0V, f=1MHz		3147		pF
Crss	Reverse Capacitance	1-111112		196		
T _{D(ON)}	Turn-on delay time			45		
Tr	Rise time	VGS=4.5V, RL=1Ω		83		no
T _{D(OFF)}	Turn-off delay time	VDS=20V , RG=3Ω		56		ns
Tf	Fall time			34		
Q _G	Total Gate Charge	VCC-4 EV VDC-45V		44		
Q _{GS}	Gate Source Charge	VGS=4.5V, VDS=15V ID=30A		28		nC
Q _{GD}	Gate Drain Charge	ID-30A		9.5		
Trr	Diode Recovery Time	IF=30A , di/dt=100A/us		62		ns
Qrr	Diode Recovery Charge	IF=30A , di/dt=100A/us		99		nC

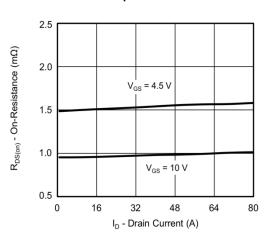


➤ Typical Characteristics(T_A=25°C unless otherwise noted)

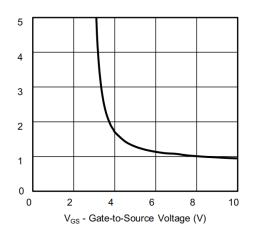




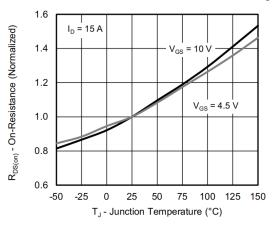
Output Characteristics



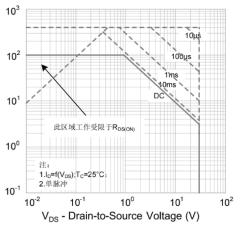
Transfer Characteristics



On-Resistance vs. Drain Current and Gate Voltage



On-Resistance vs. Gate-to-Source Voltage



On-Resistance vs. Junction Temperature

Safe Operating Area, Junction-to-Ambient

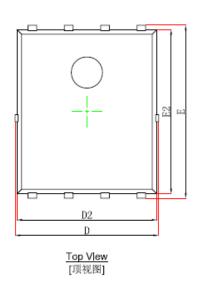
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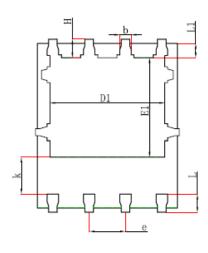
R_{DS(on)} - On-Resistance (mΩ)

I_D - Drain Current (A)

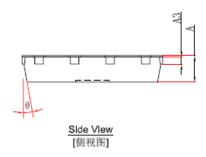


Package Information





Bottom Vlew [背视图]



Package: PDNF5X6-8L

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
Α	0.900	1.000	0.035	0.039
A3	0.254	1REF	0.010	DREF
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	3.910	4.110	0.154	0.162
E1	3.375	3.575	0.133	0.141
D2	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
е	1.270	TYP	0.050	OTYP
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
Н	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°



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